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"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded -</u> <u>Microcontrollers</u>"

Details

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	40MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, HLVD, POR, PWM, WDT
Number of I/O	25
Program Memory Size	32KB (16K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	1.5K x 8
Voltage - Supply (Vcc/Vdd)	2V ~ 5.5V
Data Converters	A/D 10x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	28-SOIC (0.295", 7.50mm Width)
Supplier Device Package	28-SOIC
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18lf2510-i-so

Email: info@E-XFL.COM

Address: Room A, 16/F, Full Win Commercial Centre, 573 Nathan Road, Mongkok, Hong Kong

TABLE 2-1: PIN DESCRIPTIONS (DURING PROGRAMMING): PIC18F2XXX/4XXX FAMILY

D : 11	During Programming			
Pin Name	Pin Name	Pin Type	Pin Description	
MCLR/Vpp/RE3	Vpp	Р	Programming Enable	
VDD ⁽²⁾	Vdd	Р	Power Supply	
VSS ⁽²⁾	Vss	Р	Ground	
RB5	PGM	I	Low-Voltage ICSP [™] Input when LVP Configuration bit equals '1' ⁽¹⁾	
RB6	PGC	I	Serial Clock	
RB7	PGD	I/O	Serial Data	

Legend: I = Input, O = Output, P = Power

Note 1: See Figure 5-1 for more information.

2: All power supply (VDD) and ground (VSS) pins must be connected.

The following devices are included in 28-pin SPDIP, PDIP and SOIC parts:

- PIC18F2221
- PIC18F2321
- PIC18F2410
- PIC18F2420
- PIC18F2423
- PIC18F2450
- PIC18F2455
- PIC18F2458

- PIC18F2480
- PIC18F2510
- PIC18F2515PIC18F2520
- PIC18F2523
- PIC18F2525
- PIC18F2550
- PIC18F2553
-

• PIC18F2321

PIC18F2620PIC18F2680

• PIC18F2580

PIC18F2585

• PIC18F2610

- PIC18F2682
- PIC18F2685

The following devices are included in 28-pin SSOP parts:

• PIC18F2221

FIGURE 2-1: 28-Pin SPDIP, PDIP, SOIC, SSOP

MCLR/VPP/RE3	°	28 RB7/PGD
RAO	2	27 RB6/PGC
RA1	3	26 RB5/PGM
RA2	4	25 RB4
RA3	0 6 8 2 9 5 9 5 9 5 9 5 9 5 9 5 9 5 9 5 9 5 9	24 🗌 RB3
RA4	6 🎗	23 RB2
RA5	7 🖸	22 RB1
	8 8	21 RB0
OSC1	9 <u>0</u>	
OSC2	10 L	
RC0	11	18 RC7
RC1	12	17 🗌 RC6
RC2	13	16 RC5
RC3	14	15 RC4

The following devices are included in 28-pin QFN parts:

PIC18F2221PIC18F2321

• PIC18F2410

• PIC18F2420

PIC18F2423PIC18F2450

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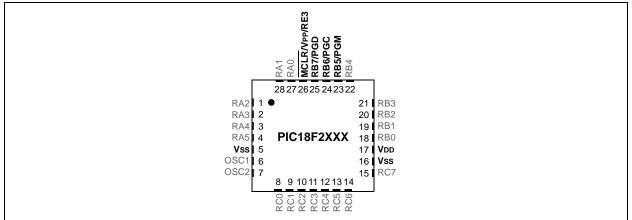
• PIC18F2480

- PIC18F2510
 DIC18F2520
 - PIC18F2520

.

- PIC18F2523
- PIC18F2580
- PIC18F2682
- PIC18F2685

FIGURE 2-2: 28-Pin QFN



The following devices are included in 40-pin PDIP parts:

- PIC18F4221
- PIC18F4321
- PIC18F4410
- PIC18F4420
- PIC18F4423
- PIC18F4450
- PIC18F4458PIC18F4480PIC18F4510

• PIC18F4455

- PIC18F4515PIC18F4520
- PIC18F4523PIC18F4525
- PIC18F4550
- PIC18F4553
- PIC18F4580
- PIC18F4585

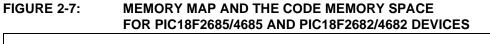
- PIC18F4610
- PIC18F4620
- PIC18F4680
- PIC18F4682
- PIC18F4685

•

FIGURE 2-3: 40-P

40-Pin PDIP

MCLR/Vpp/RE3	°	40 RB7/PGD
RAO		39 B RB6/PGC
RA1		38 🗖 RB5/PGM
RA2		37 🗖 RB4
RA3		36 🗖 RB3
RA4	6	35 🗖 RB2
RA5	7	34 🗖 RB1
RE0	8 🎽	33 🗖 RB0
RE1	9 🗙	32 🗍 VDD
RE2		31 🗖 Vss
VDD	11 8	30 🗌 RD7
Vss	12 Ú	29 🗖 RD6
OSC1		28 RD5
OSC2		27 🗖 RD4
RC0		26 🗖 RC7
RC1		25 RC6
RC2		24 C5
RC3		23 RC4
RD0		22 RD3
RD1	20	21 RD2



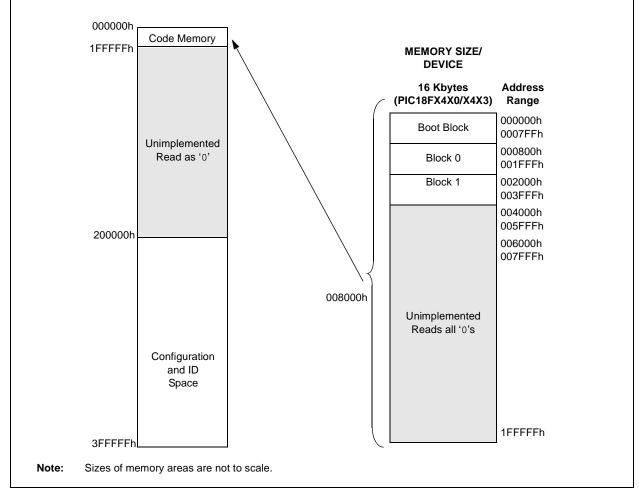
000000h					MEMORY S	IZE/DEVICE			Addre Rang
)1FFFFh	Code Memory		96 Kbytes (PIC18F2685/4685)			80 Kbytes (PIC18F2682/4682)			Tung
					BBSIZ1	BBSIZ2			
			11/10	01	00	11/10	01	00	
				Boot Block*	Boot Block*	Boot Block* Block 0 Block 0		Boot Block*	000000h 0007FFh 000800h 000FFFh
	Unimplemented Read as '0'		Boot Block*				Block*		
					Block 0			Block 0	00100 001FF
			Block 0	Block 0	DIOCK		Block 0		00200
200000h									003FF 00400
				Block 1			Block 1		
				Block 2			Block 2		007FF 00800
	Configuration and ID	-	Block 3			Block 3			00BFF 00C00
	Space		Block 4			Block 4		00FFF 01000	
									013FF 01400
			Block 5			Unimplemented		017FF	
BFFFFFh				Inimplemented Reads all '0's	b		Reads all '0's		01FFF

For PIC18FX5X0/X5X3 devices, the code memory space extends from 000000h to 007FFFh (32 Kbytes) in four 8-Kbyte blocks. For PIC18FX4X5/X4X8 devices, the code memory space extends from 000000h to 005FFFh (24 Kbytes) in three 8-Kbyte blocks. Addresses, 000000h through 0007FFh, however, define a "Boot Block" region that is treated separately from Block 0. All of these blocks define code protection boundaries within the code memory space.

TABLE 2-5: IMPLEMENTATION OF CODE MEMORY

Device	Code Memory Size (Bytes)
PIC18F2410	
PIC18F2420	
PIC18F2423	
PIC18F2450	000000h-003FFFh (16K)
PIC18F4410	
PIC18F4420	
PIC18F4450	

FIGURE 2-9: MEMORY MAP AND THE CODE MEMORY SPACE FOR PIC18FX4X0/X4X3 DEVICES



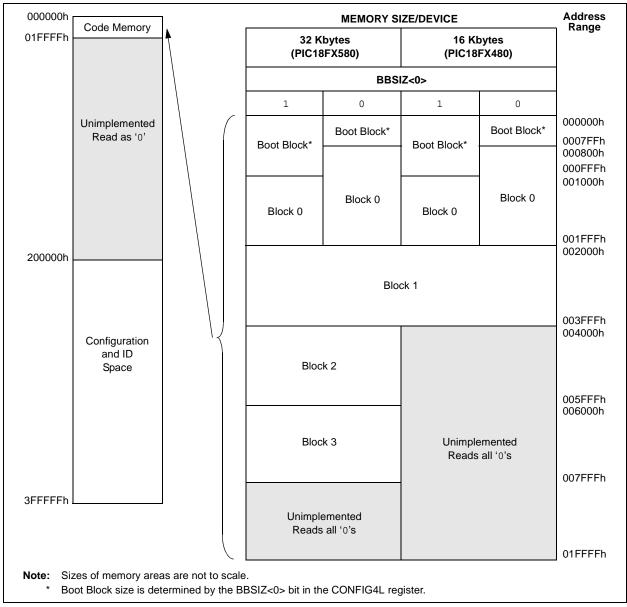
For PIC18F2480/4480 devices, the code memory space extends from 0000h to 03FFFh (16 Kbytes) in one 16-Kbyte block. For PIC18F2580/4580 devices, the code memory space extends from 0000h to 07FFFh (32 Kbytes) in two 16-Kbyte blocks. Addresses, 0000h through 07FFh, however, define a "Boot Block" region that is treated separately from Block 0. All of these blocks define code protection boundaries within the code memory space.

The size of the Boot Block in PIC18F2480/2580/4480/4580 devices can be configured as 1 or 2K words (see Figure 2-10). This is done through the BBSIZ<0> bit in the Configuration register, CONFIG4L. It is important to note that increasing the size of the Boot Block decreases the size of Block 0.

TABLE 2-6:IMPLEMENTATION OF CODE MEMORY

Device	Code Memory Size (Bytes)
PIC18F2480	
PIC18F4480	000000h-003FFFh (16K)
PIC18F2580	000000h 007EEEh (22K)
PIC18F4580	000000h-007FFFh (32K)

FIGURE 2-10: MEMORY MAP AND THE CODE MEMORY SPACE FOR PIC18F2480/2580/4480/4580 DEVICES



For PIC18F2221/4221 devices, the code memory space extends from 0000h to 00FFFh (4 Kbytes) in one 4-Kbyte block. For PIC18F2321/4321 devices, the code memory space extends from 0000h to 01FFFh (8 Kbytes) in two 4-Kbyte blocks. Addresses, 0000h through 07FFh, however, define a variable "Boot Block" region that is treated separately from Block 0. All of these blocks define code protection boundaries within the code memory space.

2.7 Serial Program/Verify Operation

The PGC pin is used as a clock input pin and the PGD pin is used for entering command bits and data input/output during serial operation. Commands and data are transmitted on the rising edge of PGC, latched on the falling edge of PGC and are Least Significant bit (LSb) first.

2.7.1 4-BIT COMMANDS

All instructions are 20 bits, consisting of a leading 4-bit command followed by a 16-bit operand, which depends on the type of command being executed. To input a command, PGC is cycled four times. The commands needed for programming and verification are shown in Table 2-8.

Depending on the 4-bit command, the 16-bit operand represents 16 bits of input data or 8 bits of input data and 8 bits of output data.

Throughout this specification, commands and data are presented as illustrated in Table 2-9. The 4-bit command is shown Most Significant bit (MSb) first. The command operand, or "Data Payload", is shown as <MSB><LSB>. Figure 2-18 demonstrates how to serially present a 20-bit command/operand to the device.

2.7.2 CORE INSTRUCTION

The core instruction passes a 16-bit instruction to the CPU core for execution. This is needed to set up registers as appropriate for use with other commands.

TABLE 2-8: COMMANDS FOR PROGRAMMING

Description	4-Bit Command
Core Instruction (Shift in16-bit instruction)	0000
Shift Out TABLAT Register	0010
Table Read	1000
Table Read, Post-Increment	1001
Table Read, Post-Decrement	1010
Table Read, Pre-Increment	1011
Table Write	1100
Table Write, Post-Increment by 2	1101
Table Write, Start Programming, Post-Increment by 2	1110
Table Write, Start Programming	1111

TABLE 2-9: SAMPLE COMMAND SEQUENCE

4-Bit Command	Data Payload	Core Instruction
1101	3C 40	Table Write,
		post-increment by 2

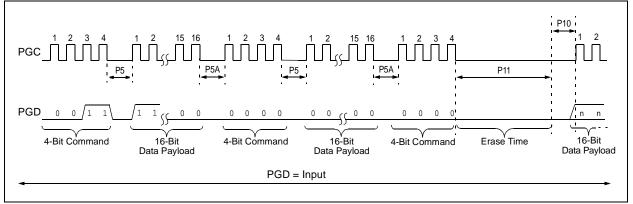
3.1.2 LOW-VOLTAGE ICSP BULK ERASE

When using low-voltage ICSP, the part must be supplied by the voltage specified in Parameter D111 if a Bulk Erase is to be executed. All other Bulk Erase details, as described above, apply.

If it is determined that a program memory erase must be performed at a supply voltage below the Bulk Erase limit, refer to the erase methodology described in Section 3.1.3 "ICSP Row Erase" and Section 3.2.1 "Modifying Code Memory".

If it is determined that a data EEPROM erase (selected devices only, see Section 3.3 "Data EEPROM Programming") must be performed at a supply voltage below the Bulk Erase limit, follow the methodology described in Section 3.3 "Data EEPROM Programming" and write '1's to the array.





3.1.3 ICSP ROW ERASE

Regardless of whether high or low-voltage ICSP is used, it is possible to erase one row (64 bytes of data), provided the block is not code or write-protected. Rows are located at static boundaries, beginning at program memory address, 000000h, extending to the internal program memory limit (see Section 2.3 "Memory Maps").

The Row Erase duration is externally timed and is controlled by PGC. After the WR bit in EECON1 is set, a NOP is issued, where the 4th PGC is held high for the duration of the programming time, P9.

After PGC is brought low, the programming sequence is terminated. PGC must be held low for the time specified by Parameter P10 to allow high-voltage discharge of the memory array.

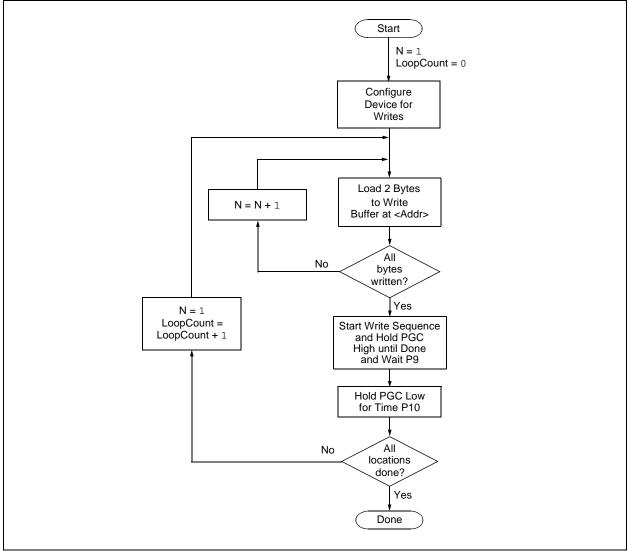
The code sequence to Row Erase a PIC18F2XXX/4XXX Family device is shown in Table 3-3. The flowchart, shown in Figure 3-3, depicts the logic necessary to completely erase a PIC18F2XXX/4XXX Family device. The timing diagram that details the Start Programming command and Parameters P9 and P10 is shown in Figure 3-5.

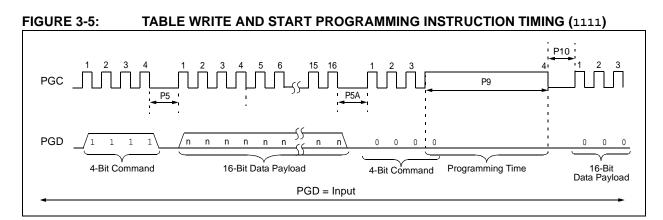
Note: The TBLPTR register can point to any byte within the row intended for erase.

4-Bit Command	Data Payload	Core Instruction		
Step 1: Direct acc	cess to code memory an	d enable writes.		
0000	8E A6 9C A6	BSF EECON1, EEPGD BCF EECON1, CFGS		
Step 2: Load write	e buffer.			
0000 0000 0000 0000 0000 0000 Step 3: Repeat fo	0E <addr[21:16]> 6E F8 0E <addr[15:8]> 6E F7 0E <addr[7:0]> 6E F6 r all but the last two byte</addr[7:0]></addr[15:8]></addr[21:16]>	MOVLW <addr[21:16]> MOVWF TBLPTRU MOVUW <addr[15:8]> MOVWF TBLPTRH MOVLW <addr[7:0]> MOVWF TBLPTRL</addr[7:0]></addr[15:8]></addr[21:16]>		
1101	<msb><lsb></lsb></msb>	Write 2 bytes and post-increment address by 2.		
Step 4: Load write buffer for last two bytes.				
1111 0000	<msb><lsb></lsb></msb>	Write 2 bytes and start programming. NOP - hold PGC high for time P9 and low for time P10.		
To continue writing data, repeat Steps 2 through 4, where the Address Pointer is incremented by 2 at each iteration of the loop.				

TABLE 3-5: WRITE CODE MEMORY CODE SEQUENCE







3.2.1 MODIFYING CODE MEMORY

The previous programming example assumed that the device had been Bulk Erased prior to programming (see **Section 3.1.1 "High-Voltage ICSP Bulk Erase**"). It may be the case, however, that the user wishes to modify only a section of an already programmed device.

The appropriate number of bytes required for the erase buffer must be read out of code memory (as described in Section 4.2 "Verify Code Memory and ID Locations") and buffered. Modifications can be made on this buffer. Then, the block of code memory that was read out must be erased and rewritten with the modified data.

The WREN bit must be set if the WR bit in EECON1 is used to initiate a write sequence.

4-Bit Command	Data Payload	Core Instruction
Step 1: Direct ac	ccess to code memory.	
Step 2: Read an	d modify code memory (see S	ection 4.1 "Read Code Memory, ID Locations and Configuration Bits").
0000	8E A6	BSF EECON1, EEPGD
0000	9C A6	BCF EECON1, CFGS
Step 3: Set the T	Table Pointer for the block to b	e erased.
0000	0E <addr[21:16]></addr[21:16]>	MOVLW <addr[21:16]></addr[21:16]>
0000	6E F8	MOVWF TBLPTRU
0000	0E <addr[8:15]></addr[8:15]>	MOVLW <addr[8:15]></addr[8:15]>
0000	6E F7	MOVWF TBLPTRH
0000	0E <addr[7:0]></addr[7:0]>	MOVLW <addr[7:0]></addr[7:0]>
0000	6E F6	MOVWF TBLPTRL
Step 4: Enable r	nemory writes and set up an e	rase.
0000	84 A6	BSF EECON1, WREN
0000	88 A6	BSF EECON1, FREE
Step 5: Initiate e	rase.	
0000	82 A6	BSF EECON1, WR
0000	00 00	NOP - hold PGC high for time P9 and low for time P10.
Step 6: Load wri	te buffer. The correct bytes wi	Il be selected based on the Table Pointer.
0000	0E <addr[21:16]></addr[21:16]>	MOVLW <addr[21:16]></addr[21:16]>
0000	6E F8	MOVWF TBLPTRU
0000	0E <addr[8:15]></addr[8:15]>	MOVLW <addr[8:15]></addr[8:15]>
0000	6E F7	MOVWF TBLPTRH
0000	0E <addr[7:0]></addr[7:0]>	MOVLW <addr[7:0]></addr[7:0]>
0000	6E F6	MOVWF TBLPTRL
1101	<msb><lsb></lsb></msb>	Write 2 bytes and post-increment address by 2.
•		Repeat as many times as necessary to fill the write buffer
1111	<msb><lsb></lsb></msb>	Write 2 bytes and start programming.
0000	00 00	NOP - hold PGC high for time P9 and low for time P10.
	at each iteration of the loop. T	bugh 6, where the Address Pointer is incremented by the appropriate number of byte he write cycle must be repeated enough times to completely rewrite the contents of
Step 7: Disable	writes.	
0000	94 A6	BCF EECON1, WREN

TABLE 3-6: MODIFYING CODE MEMORY

TABLE 3-7: PROGRAMMING DATA MEMORY

4-Bit Command	Data Payload	Core Instruction			
Step 1: Direct acc	Step 1: Direct access to data EEPROM.				
0000 0000	9E A6 9C A6	BCF EECON1, EEPGD BCF EECON1, CFGS			
Step 2: Set the da	ata EEPROM Address Pointe	er.			
0000 0000 0000 0000	OE <addr> 6E A9 OE <addrh> 6E AA</addrh></addr>	MOVLW <addr> MOVWF EEADR MOVLW <addrh> MOVWF EEADRH</addrh></addr>			
Step 3: Load the	data to be written.				
0000 0000	OE <data> 6E A8</data>	MOVLW <data> MOVWF EEDATA</data>			
Step 4: Enable m	emory writes.				
0000	84 A6	BSF EECON1, WREN			
Step 5: Initiate wi	rite.				
0000	82 A6	BSF EECON1, WR			
Step 6: Poll WR b	pit, repeat until the bit is clear	r.			
0000 0000 0000 0010	50 A6 6E F5 00 00 <msb><lsb></lsb></msb>	MOVF EECON1, W, O MOVWF TABLAT NOP Shift out data(1)			
Step 7: Hold PGC	Step 7: Hold PGC low for time P10.				
Step 8: Disable w	vrites.				
0000	94 A6	BCF EECON1, WREN			
Repeat Steps 2 th	Repeat Steps 2 through 8 to write more data.				

Note 1: See Figure 4-4 for details on shift out data timing.

4.0 READING THE DEVICE

4.1 Read Code Memory, ID Locations and Configuration Bits

Code memory is accessed, one byte at a time, via the 4-bit command, '1001' (Table Read, post-increment). The contents of memory pointed to by the Table Pointer (TBLPTRU:TBLPTRH:TBLPTRL) are serially output on PGD.

The 4-bit command is shifted in, LSb first. The read is executed during the next eight clocks, then shifted out on PGD during the last eight clocks, LSb to MSb. A delay of P6 must be introduced after the falling edge of the 8th PGC of the operand to allow PGD to transition from an input to an output. During this time, PGC must be held low (see Figure 4-1). This operation also increments the Table Pointer by one, pointing to the next byte in code memory for the next read.

This technique will work to read any memory in the 000000h to 3FFFFFh address space, so it also applies to the reading of the ID and Configuration registers.

4-Bit Command	Data Payload	Core Instruction				
Step 1: Set Table	Pointer.					
0000 0000 0000 0000 0000 0000	<pre>0E <addr[21:16]> 6E F8 0E <addr[15:8]> 6E F7 0E <addr[7:0]> 6E F6</addr[7:0]></addr[15:8]></addr[21:16]></pre>	MOVLW Addr[21:16] MOVWF TBLPTRU MOVLW <addr[15:8]> MOVWF TBLPTRH MOVLW <addr[7:0]> MOVWF TBLPTRL</addr[7:0]></addr[15:8]>				
Step 2: Read mer	Step 2: Read memory and then shift out on PGD, LSb to MSb.					
1001	00 00	TBLRD *+				

 TABLE 4-1:
 READ CODE MEMORY SEQUENCE



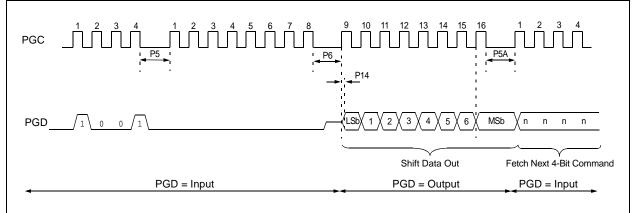


TABLE 5-1: CONFIGURATION BITS AND DEVICE IDS

File Name		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Default/ Unprogrammed Value
300000h ^(1,8)	CONFIG1L		_	USBDIV	CPUDIV1	CPUDIV0	PLLDIV2	PLLDIV1	PLLDIV0	00 0000
300001h	CONFIG1H	IESO	FCMEN			FOSC3	FOSC2	FOSC1	FOSC0	00 0111
30000 111	CONTONT	1200	TOWEN			10000	10002	10001	10000	00 0101 ^(1,8)
300002h	CONFIG2L			_	BORV1	BORV0	BOREN1	BOREN0	PWRTEN	1 1111
30000211				VREGEN ^(1,8)	BORVI	BORVU	BORLINI	BORLINU	FWINILIN	01 1111 (1,8)
300003h	CONFIG2H	—	—	_	WDTPS3	WDTPS2	WDTPS1	WDTPS0	WDTEN	1 1111
300005h	CONFIG3H	MCLRE	_	_	_	_	LPT1OSC	PBADEN	CCP2MX ⁽⁷⁾	1011 (7)
00000011		MOEINE					LI I I OOO	TBREEN	—	101-
	CONFIG4L			ICPRT ⁽¹⁾	—	-	LVP	_	STVREN	1001-1 ⁽¹⁾
				BBSIZ1	BBSIZ0	_				1000 -1-1
300006h		DEBUG	XINST	_	BBSIZ ⁽³⁾	_				10-0 -1-1 (3)
				ICPRT ⁽⁸⁾	—	BBSIZ ⁽⁸⁾				100- 01-1 ⁽⁸⁾
				BBSIZ1 ⁽²⁾	BBSIZ2(2)	-				1000 -1-1 (2)
300008h	CONFIG5L	_	—	CP5 ⁽¹⁰⁾	CP4 ⁽⁹⁾	CP3 ⁽⁴⁾	CP2 ⁽⁴⁾	CP1	CP0	11 1111
300009h	CONFIG5H	CPD	CPB	_	—	-	—	-	—	11
30000Ah	CONFIG6L	_	—	WRT5 ⁽¹⁰⁾	WRT4 ⁽⁹⁾	WRT3 ⁽⁴⁾	WRT2 ⁽⁴⁾	WRT1	WRT0	11 1111
30000Bh	CONFIG6H	WRTD	WRTB	WRTC ⁽⁵⁾	_		_		—	111
30000Ch	CONFIG7L		_	EBTR5 ⁽¹⁰⁾	EBTR4 ⁽⁹⁾	EBTR3 ⁽⁴⁾	EBTR2 ⁽⁴⁾	EBTR1	EBTR0	11 1111
30000Dh	CONFIG7H		EBTRB		_		_	-	_	-1
3FFFFEh	DEVID1 ⁽⁶⁾	DEV2	DEV1	DEV0	REV4	REV3	REV2	REV1	REV0	See Table 5-2
3FFFFFh	DEVID2 ⁽⁶⁾	DEV10	DEV9	DEV8	DEV7	DEV6	DEV5	DEV4	DEV3	See Table 5-2

Legend: -= unimplemented. Shaded cells are unimplemented, read as '0'.

Note 1: Implemented only on PIC18F2455/2550/4455/4550 and PIC18F2458/2553/4458/4553 devices.

2: Implemented on PIC18F2585/2680/4585/4680, PIC18F2682/2685 and PIC18F4682/4685 devices only.

3: Implemented on PIC18F2480/2580/4480/4580 devices only.

4: These bits are only implemented on specific devices based on available memory. Refer to Section 2.3 "Memory Maps".

5: In PIC18F2480/2580/4480/4580 devices, this bit is read-only in Normal Execution mode; it can be written only in Program mode.

6: DEVID registers are read-only and cannot be programmed by the user.

7: Implemented on all devices with the exception of the PIC18FXX8X and PIC18F2450/4450 devices.

8: Implemented on PIC18F2450/4450 devices only.

9: Implemented on PIC18F2682/2685 and PIC18F4682/4685 devices only.

10: Implemented on PIC18F2685/4685 devices only.

TABLE 5-2: DEVICE ID VALUES (CONTINUED)

Device	Device ID Value				
Device	DEVID2	DEVID1			
PIC18F4585	0Eh	101x xxxx			
PIC18F4610	0Ch	001x xxxx			
PIC18F4620	0Ch	000x xxxx			
PIC18F4680	0Eh	100x xxxx			
PIC18F4682	27h	010x xxxx			
PIC18F4685	27h	011x xxxx			

Legend: The 'x's in DEVID1 contain the device revision code.

Note 1: DEVID1 bit 4 is used to determine the device type (REV4 = 0).

2: DEVID1 bit 4 is used to determine the device type (REV4 = 1).

TABLE 5-3: PIC18F2XXX/4XXX FAMILY BIT DESCRIPTIONS (CONTINUED)

Bit Name	Configuration Words	Description
PLLDIV<2:0>	CONFIG1L	Oscillator Selection bits (PIC18F2455/2550/4455/4550, PIC18F2458/2553/4458/4553 and PIC18F2450/4450 devices only)
		Divider must be selected to provide a 4 MHz input into the 96 MHz PLL: 111 = Oscillator divided by 12 (48 MHz input) 110 = Oscillator divided by 10 (40 MHz input) 101 = Oscillator divided by 6 (24 MHz input) 100 = Oscillator divided by 5 (20 MHz input) 011 = Oscillator divided by 4 (16 MHz input) 010 = Oscillator divided by 3 (12 MHz input) 001 = Oscillator divided by 2 (8 MHz input) 000 = No divide – oscillator used directly (4 MHz input)
VREGEN	CONFIG2L	USB Voltage Regulator Enable bit (PIC18F2455/2550/4455/4550, PIC18F2458/2553/4458/4553 and PIC18F2450/4450 devices only) 1 = USB voltage regulator is enabled
BORV<1:0>	CONFIG2L	0 = USB voltage regulator is disabled Brown-out Reset Voltage bits 11 = VBOR is set to 2.0V 10 = VBOR is set to 2.7V 01 = VBOR is set to 4.2V 00 = VBOR is set to 4.5V
BOREN<1:0>	CONFIG2L	 Brown-out Reset Enable bits 11 = Brown-out Reset is enabled in hardware only (SBOREN is disabled) 10 = Brown-out Reset is enabled in hardware only and disabled in Sleep mode SBOREN is disabled) 01 = Brown-out Reset is enabled and controlled by software (SBOREN is enabled) 00 = Brown-out Reset is disabled in hardware and software
PWRTEN	CONFIG2L	Power-up Timer Enable bit 1 = PWRT is disabled 0 = PWRT is enabled
WDPS<3:0>	CONFIG2H	Watchdog Timer Postscaler Select bits 1111 = 1:32,768 1110 = 1:16,384 1101 = 1:8,192 1100 = 1:4,096 1011 = 1:2,048 1010 = 1:1,024 1001 = 1:512 1000 = 1:256 0111 = 1:128 0110 = 1:64 0101 = 1:32 0100 = 1:16 0011 = 1:8 0010 = 1:4 0001 = 1:2
		0000 = 1:1 000 = 1:1

Note 1: The BBSIZ bits, BBSIZ<1:0> and BBSIZ<2:1> bits, cannot be changed once any of the following code-protect bits are enabled: CPB or CP0, WRTB or WRT0, EBTRB or EBTR0.

Bit Name	Configuration Words	Description
WDTEN	CONFIG2H	Watchdog Timer Enable bit
		1 = WDT is enabled
		0 = WDT is disabled (control is placed on the SWDTEN bit)
MCLRE	CONFIG3H	MCLR Pin Enable bit
		$1 = \overline{MCLR}$ pin is enabled, RE3 input pin is disabled
		0 = RE3 input pin is enabled, MCLR pin is disabled
LPT1OSC	CONFIG3H	Low-Power Timer1 Oscillator Enable bit
		1 = Timer1 is configured for low-power operation
		0 = Timer1 is configured for high-power operation
PBADEN	CONFIG3H	PORTB A/D Enable bit
		 1 = PORTB A/D<4:0> pins are configured as analog input channels on Reset 0 = PORTB A/D<4:0> pins are configured as digital I/O on Reset
PBADEN	CONFIG3H	PORTB A/D Enable bit (PIC18FXX8X devices only)
FDADEN	CONFIGSH	1 = PORTB A/D < 4:0> and PORTB A/D<1:0> pins are configured as analog input
		channels on Reset
		0 = PORTB A/D<4:0> pins are configured as digital I/O on Reset
CCP2MX	CONFIG3H	CCP2 MUX bit
		1 = CCP2 input/output is multiplexed with RC1 ⁽²⁾
		0 = CCP2 input/output is multiplexed with RB3
DEBUG	CONFIG4L	Background Debugger Enable bit
		1 = Background debugger is disabled, RB6 and RB7 are configured as general
		purpose I/O pins
		0 = Background debugger is enabled, RB6 and RB7 are dedicated to In-Circuit Debug
XINST	CONFIG4L	Extended Instruction Set Enable bit
		1 = Instruction set extension and Indexed Addressing mode are enabled
		0 = Instruction set extension and Indexed Addressing mode are disabled
		(Legacy mode)
ICPRT	CONFIG4L	Dedicated In-Circuit (ICD/ICSP™) Port Enable bit
		(PIC18F2455/2550/4455/4550, PIC18F2458/2553/4458/4553 and
		PIC18F2450/4450 devices only)
		1 = ICPORT is enabled 0 = ICPORT is disabled
BBSIZ<1:0> ⁽¹⁾	CONFIG4L	Boot Block Size Select bits (PIC18F2585/2680/4585/4680 devices only)
	OON 104L	11 = 4K words (8 Kbytes) Boot Block
		10 = 4K words (8 Kbytes) Boot Block
		01 = 2K words (4 Kbytes) Boot Block
		00 = 1K word (2 Kbytes) Boot Block
BBSIZ<2:1> ⁽¹⁾	CONFIG4L	Boot Block Size Select bits (PIC18F2682/2685/4582/4685 devices only)
		11 = 4K words (8 Kbytes) Boot Block
		10 = 4K words (8 Kbytes) Boot Block
		01 = 2K words (4 Kbytes) Boot Block 00 = 1K word (2 Kbytes) Boot Block
	1	10 and BBSIZ-2:1> bits, cannot be changed once any of the following

TABLE 5-3: PIC18F2XXX/4XXX FAMILY BIT DESCRIPTIONS (CONTINUED)

Note 1: The BBSIZ bits, BBSIZ<1:0> and BBSIZ<2:1> bits, cannot be changed once any of the following code-protect bits are enabled: CPB or CP0, WRTB or WRT0, EBTRB or EBTR0.

Bit Name	Configuration Words	Description
WRT5	CONFIG6L	Write Protection bit (Block 5 code memory area) (PIC18F2685 and PIC18F4685 devices only)
		 1 = Block 5 is not write-protected 0 = Block 5 is write-protected
WRT4	CONFIG6L	Write Protection bit (Block 4 code memory area) (PIC18F2682/2685 and PIC18F4682/4685 devices only)
		1 = Block 4 is not write-protected0 = Block 4 is write-protected
WRT3	CONFIG6L	Write Protection bit (Block 3 code memory area)
		1 = Block 3 is not write-protected
		0 = Block 3 is write-protected
WRT2	CONFIG6L	Write Protection bit (Block 2 code memory area)
		1 = Block 2 is not write-protected0 = Block 2 is write-protected
WRT1	CONFIG6L	Write Protection bit (Block 1 code memory area)
		1 = Block 1 is not write-protected0 = Block 1 is write-protected
WRT0	CONFIG6L	Write Protection bit (Block 0 code memory area)
		1 = Block 0 is not write-protected
		0 = Block 0 is write-protected
WRTD	CONFIG6H	Write Protection bit (Data EEPROM)
		 1 = Data EEPROM is not write-protected 0 = Data EEPROM is write-protected
WRTB	CONFIG6H	Write Protection bit (Boot Block memory area)
		1 = Boot Block is not write-protected
		0 = Boot Block is write-protected
WRTC	CONFIG6H	Write Protection bit (Configuration registers)
		1 = Configuration registers are not write-protected
		0 = Configuration registers are write-protected
EBTR5	CONFIG7L	Table Read Protection bit (Block 5 code memory area) (PIC18F2685 and PIC18F4685 devices only)
		 1 = Block 5 is not protected from Table Reads executed in other blocks 0 = Block 5 is protected from Table Reads executed in other blocks
EBTR4	CONFIG7L	Table Read Protection bit (Block 4 code memory area) (PIC18F2682/2685 and PIC18F4682/4685 devices only)
		 1 = Block 4 is not protected from Table Reads executed in other blocks 0 = Block 4 is protected from Table Reads executed in other blocks
EBTR3	CONFIG7L	Table Read Protection bit (Block 3 code memory area)
		 1 = Block 3 is not protected from Table Reads executed in other blocks 0 = Block 3 is protected from Table Reads executed in other blocks
EBTR2	CONFIG7L	Table Read Protection bit (Block 2 code memory area)
		1 = Block 2 is not protected from Table Reads executed in other blocks
		0 = Block 2 is protected from Table Reads executed in other blocks
EBTR1	CONFIG7L	Table Read Protection bit (Block 1 code memory area)
		 1 = Block 1 is not protected from Table Reads executed in other blocks 0 = Block 1 is protected from Table Reads executed in other blocks

TABLE 5-3:	PIC18F2XXX/4XXX FAMILY BIT DESCRIPTIONS ((CONTINUED)

Note 1: The BBSIZ bits, BBSIZ<1:0> and BBSIZ<2:1> bits, cannot be changed once any of the following code-protect bits are enabled: CPB or CP0, WRTB or WRT0, EBTRB or EBTR0.

Bit Name	Configuration Words	Description
EBTR0	CONFIG7L	Table Read Protection bit (Block 0 code memory area)
		 1 = Block 0 is not protected from Table Reads executed in other blocks 0 = Block 0 is protected from Table Reads executed in other blocks
EBTRB	CONFIG7H	Table Read Protection bit (Boot Block memory area)
		 1 = Boot Block is not protected from Table Reads executed in other blocks 0 = Boot Block is protected from Table Reads executed in other blocks
DEV<10:3>	DEVID2	Device ID bits
		These bits are used with the DEV<2:0> bits in the DEVID1 register to identify part number.
DEV<2:0>	DEVID1	Device ID bits
		These bits are used with the DEV<10:3> bits in the DEVID2 register to identify part number.
REV<4:0>	DEVID1	Revision ID bits
		These bits are used to indicate the revision of the device. The REV4 bit is sometimes used to fully specify the device type.

TABLE 5-3: PIC18F2XXX/4XXX FAMILY BIT DESCRIPTIONS (CONTINUED)

Note 1: The BBSIZ bits, BBSIZ<1:0> and BBSIZ<2:1> bits, cannot be changed once any of the following code-protect bits are enabled: CPB or CP0, WRTB or WRT0, EBTRB or EBTR0.

6.0 AC/DC CHARACTERISTICS TIMING REQUIREMENTS FOR PROGRAM/VERIFY TEST MODE (CONTINUED)

	Standard Operating Conditions Operating Temperature: 25°C is recommended								
Param No.	Sym	Characteristic	Min	Max	Units	Conditions			
P11A	Tdrwt	Data Write Polling Time	4	—	ms				
P12	THLD2	Input Data Hold Time from MCLR/VPP/RE3 ↑	2	_	μS				
P13	TSET2	VDD ↑ Setup Time to MCLR/VPP/RE3 ↑	100	_	ns	(Note 2)			
P14	TVALID	Data Out Valid from PGC ↑	10	—	ns				
P15	TSET3	PGM [↑] Setup Time to MCLR/VPP/RE3 [↑]	2	—	μS	(Note 2)			
P16	TDLY8	Delay Between Last PGC \downarrow and $\overline{\mathrm{MCLR}}/\mathrm{VPP}/\mathrm{RE3}\downarrow$	0	_	S				
P17	THLD3	MCLR/VPP/RE3 ↓ to VDD ↓	_	100	ns				
P18	THLD4	MCLR/VPP/RE3 ↓ to PGM ↓	0	_	s				

Note 1: Do not allow excess time when transitioning MCLR between VIL and VIHH. This can cause spurious program executions to occur. The maximum transition time is:

1 TCY + TPWRT (if enabled) + 1024 TOSC (for LP, HS, HS/PLL and XT modes only) +

2 ms (for HS/PLL mode only) + 1.5 μs (for EC mode only)

where TCY is the instruction cycle time, TPWRT is the Power-up Timer period and TOSC is the oscillator period. For specific values, refer to the Electrical Characteristics section of the device data sheet for the particular device.

2: When ICPRT = 1, this specification also applies to ICVPP.

3: At 0°C-50°C.

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